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Final Product Change Notification

Issue Date: 07-Aug-2019 Effective Date: 04-Nov-2019 Dear *Emma Tempest*,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP. For detailed information we invite you to <u>view this</u> notification online

This notice is NXP Company Proprietary.

201907018F01



QUALITY

Change Category				
[]Wafer Fab Process	[] Assembly Process	[] Product Marking	[] Test Location	[] Design
[] Wafer Fab Materials	[] Assembly Materials	[] Mechanical Specification	[]Test Process	[] Errata
[]Wafer Fab Location	[] Assembly Location	[X] Packing/Shipping/Labeling	[] Test Equipment	[] Electrical spec./Test coverage
] Firmware	[] Other			
Tray Supplier Change for LQFP20x20x1.4 Package from Peak to ITW in ASE- CL				

Description of Change

For products of LQFP20x20x1.4 packaged in ASE-CL, NXP will change tray supplier from Peak to ITW.

Due to the differences in seating height, the two trays are not stackable. Customers should not mix or stack the two different trays .

Please refer to attachment for the detailed change.

Reason for Change

To standardize the trays for same package size, avoid tray mixture issue.

Identification of Affected Products

There's silk screen on one side of ITW tray to differentiate with Peak tray. Please refer to the attachment for the details.

Product Availability

Sample Information Not applicable Production Planned first shipment 04-Nov-2019

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

Existing inventory will be shipped until depleted

Additional information

Affected products and sales history information: see attached file

Self qualification: view online

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 06-Sep-2019. Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please <u>contact NXP "Global Quality</u> Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: **Name** Lei Yang

Position Product Engineer

e-mail address lei.yang@nxp.com

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Customer Focus, Passion to Win.

NXP Quality Management Team. About NXP Semiconductors

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